

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6793182

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NAI-WEI LIU	03/31/2021
YEN-YAO CHI	03/31/2021
YEH-CHUN KAO	03/31/2021
SHIH-HUANG YEH	03/31/2021
TZU-HUNG LIN	03/31/2021
WEN-SUNG HSU	03/31/2021
RECEIVING PARTY DATA	
Name:	MEDIATEK INC.
Street Address:	NO. 1, DUSING RD. 1ST,
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSIN-CHU 300
State/Country:	TAIWAN
Postal Code:	ROC
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17361285
CORRESPONDENCE DATA	
Fax Number:	(617)646-8646
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	617-646-8000
Email:	evis.kapo@wolfgreenfield.com
Correspondent Name:	ROBERT A. JENSEN
Address Line 1:	WOLF, GREENFIELD & SACKS, P.C.
Address Line 2:	600 ATLANTIC AVENUE
Address Line 4:	BOSTON, MASSACHUSETTS 02210
ATTORNEY DOCKET NUMBER:	M1295.70279US02
NAME OF SUBMITTER:	EVIS KAPO
SIGNATURE:	/Evis Kapo/
DATE SIGNED:	07/01/2021

PATENT

Total Attachments: 7

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ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned Assignor, hereby:

1. Sell, assign and transfer to **MediaTek Inc.**, a Taiwan ROC Corporation having a place of business at **No. 1, Dusing Rd. 1st, Science-Based Industrial Park, Hsin-Chu 300, TAIWAN ROC**, its successors, assigns and legal representatives, all hereinafter referred to as the Assignee, my entire right, title and interest for the United States and all foreign countries, in and to any and all inventions and designs which are disclosed in the patent application for United States Letters Patent filed in the United States Patent and Trademark Office on June 25, 2019, under No. **16/452,395**, bearing Attorney Docket No. **M1295.70279US01**, and entitled **SEMICONDUCTOR PACKAGE STRUCTURE WITH ANTENNA**, and to any and all inventions and designs which are disclosed in the provisional patent application filed in the United States Patent and Trademark Office on **July 3, 2018**, under No. **62/693,501**, and entitled **NOVEL AIP 3D FAN OUT STRUCTURE** and in and to the application and all corresponding provisional, non-provisional, divisional, continuing, substitute, renewal, reissue and all other applications for Letters Patent, utility models, industrial designs or similar intellectual property rights which have been or shall be filed in the United States, internationally, and in any foreign country, including but not limited to China, Japan and Korea, on any of the inventions and designs; and in and to all original and reissued patents which have been or shall be issued in the United States or any other jurisdiction on the inventions and designs, including the right to apply for patent rights in each foreign country and all rights to priority, including the right to claim priority for China, Japan and Korea; as well as the right to sue in its own name and recover damages for past infringement of any United States Letters Patent and foreign patent, including a reasonable royalty relating to provisional rights under 35 U.S.C. § 154(d) that have attached to any published United States patent application, on the inventions and designs;
2. Agree that the Assignee may apply for and receive Letters Patent and utility model and industrial design registrations for the inventions and designs in its own name; and when requested, without charge to but at the expense of the Assignee, agree to carry out in good faith the intent and purpose of this Assignment, by executing all non-provisional, divisional, continuing, substitute, renewal, reissue, and all other patent, utility model and industrial design applications on any and all the inventions and designs, by executing all rightful oaths, assignments, powers of attorney and other papers, by communicating to the Assignee all facts known to me relating to the inventions and designs and the history thereof, and generally by doing everything reasonably possible which the Assignee shall consider desirable for aiding in securing and maintaining proper protection for the inventions and designs and for vesting title to the inventions and designs and all applications for patents and all patents on the inventions and designs, in the Assignee;
3. Request the Director of the United States Patent and Trademark Office and foreign patent authorities to issue the Letters Patent or other intellectual property rights, including foreign patents, to the Assignee;
4. Authorize and request Wolf, Greenfield & Sacks, P.C. to supply any missing application identification information or correct any errors in the application identification information provided above, whether discovered prior to or after recordation;
5. Covenant with the Assignee that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by me and that full right to convey the same as herein expressed is possessed by me; and
6. Appoint Assignee, through its designee, my attorney-in-fact to execute, in my name and on my behalf, any and all documents required to effectuate this Assignment, specifically including, but not limited to, those documents specified above and any necessary corrective assignments.

This instrument is executed under seal and signed under the pains and penalties of perjury under the laws of the United States of America.

Attorney Docket No. **M1295.70279US01**; MTK Ref. No. **MTKI-18-0329US**

2021/3/31
Date

Nai Wei Liu
Inventor: Nai-Wei Liu

Citizenship: Taiwan ROC

Witness:

Date

Signature

Name: _____

Address: _____

Witness:

Date

Signature

Name: _____

Address: _____

Attorney Docket No. M1295.70279US01; MTK Ref. No. MTKI-18-0329US

2021/3/31
Date

Yen-Yao Chi
Inventor: Yen-Yao Chi

Citizenship: Taiwan ROC

Witness:

Date

Signature

Name: _____

Address: _____

Witness:

Date

Signature

Name: _____

Address: _____

Attorney Docket No. M1295.70279US01; MTK Ref. No. MTKI-18-0329US

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2021/3/31
Date

Yeh-Chun Kao
Inventor: Yeh-Chun Kao

Citizenship: Taiwan ROC

Witness:

Date

Signature

Name: _____

Address: _____

Witness:

Date

Signature

Name: _____

Address: _____

Attorney Docket No. M1295.70279US01; MTK Ref. No. MTKI-18-0329US

2021/03/31

Date

Inventor: Shih-Huang Yeh
Shih-Huang Yeh

Citizenship: Taiwan ROC

Witness:

_____ Date

_____ Signature

Name: _____

Address: _____

Witness:

_____ Date

_____ Signature

Name: _____

Address: _____

Attorney Docket No. M1295.70279US01; MTK Ref. No. MTKI-18-0329US

7210714.1

2021/5/31
Date

Tzu-Hung Lin
Inventor: Tzu-Hung Lin

Citizenship: Taiwan ROC

Witness:

Date

Signature

Name: _____

Address: _____

Witness:

Date

Signature

Name: _____

Address: _____

Attorney Docket No. M1295.70279US01; MTK Ref. No. MTKI-18-0329US

2021/3/31
Date

Wen-Sung Hsu
Inventor: Wen-Sung Hsu

Citizenship: Taiwan ROC

Witness:

Date

Signature

Name: _____

Address: _____

Witness:

Date

Signature

Name: _____

Address: _____

Attorney Docket No. M1295.70279US01; MTK Ref. No. MTKI-18-0329US